



2022 Product List Highly Dispersed Inks, Coatings & Adhesives

Aerospace						
AS1101	ESD Coating	ESD coating ideally suited for aerospace applications requiring exceptional durability and heat resistance. <u>AS1101 Data Sheet</u>	Aerospace			
AS3201	Thermal Barrier Coating	Thermal barrier coating designed for aero- space applications that require exceptional durability under harsh conditions. <u>AS3201 Data Sheet</u>	Aerospace Aerospace			
Printed Electronics						
FE1331	Stretchable Conductive Adhesive	Silver filled, solvent free, one component conductive adhesive that remains stretchable following thermal cure. Designed for bonding to flexible substrates and accommodates in- terface stresses and strains during bending. <u>FE1331 Data Sheet</u>	FHE FHE			
FE1334	Stretchable Conductive Adhesive	Silver filled, one component epoxy that can be deposited using stencil, syringe, or jet dis- pensing. Designed for bonding components to compliant substrates and remains stretchable (up to 40% stretch) following thermal cure. <u>FE1334 Data Sheet</u>	FHE			



Printed Electronics (Continued) Epoxy based glob top encapsulant that remains stretchable following thermal cure. Stretchable Compliant for devices on flexible substrates Glob Top FE5237 Encapsulant FE5237 Data Sheet Silver filled flexible conductive trace ink for use on PET, polyimides, and other bendable Flexible substrates, offering high conductivity and low FE3124 Conductive slump for feature resolution less than 100 µm. Trace FE3124 Data Sheet Silver filled flexible conductive trace for use on PET, polyimides, and other bendable substrates. Lower viscosity than FE3124, adjusted Flexible to a level appropriate for typical screen print-FE3124-LV Conductive ing applications. FHE Trace FE3124-LV Data Sheet Carbon filled flexible conductive trace ink for use on PET, polyimides, and other bendable substrates. High conductivity for a 100% carbon conductor with rheology tailored toward Flexible low slump and fine feature resolution via FE3203 Carbon screen printing. Excellent adhesion and flex FHE Conductor ductility. FE3203 Data Sheet



Printed Electronics (Continued) Stretchable non-conductive epoxy used to bond components in flexible and stretchable Non-Conductive systems and to manage thermal expansion FE5236 Stretchable mismatches in rigid packaging solutions. Adhesive FE5236 Data Sheet **RD0117B** ACI Alchemy Conductive Inks are a series of highly conductive semi-sintering or hybrid type formulations that enable a range of advantages to current users of silver polymer thick film (PTF) and nanoparticle-based inks, pastes, and Alchemy Series coatings. These formulations offer the ease **RD0117C** Semi-Sintering of use and processing of PTF inks and Conductive Inks FHF coatings, but with the superior electrical performance of sintered nano inks. Alchemy Series Data Sheet **RD0117F**



Printed Electronics (Continued)						
SE1109	Stretchable Printed Silver Conductor	ACI SE1109 is a silver filled conductor for print- ed interconnects for devices on elastomeric substrates. After drying, the ink has excellent conductivity and offers excellent elongation and flexibility. SE1109 has been formulated for superior adhesion to thermoplastic urethanes (TPU). <u>SE1109 Data Sheet</u>	FHE Wearables			
SE1502	Stretchable Printed Carbon Conductor	Carbon filled conductor for printed circuitry and devices on elastomeric substrates, such as TPU. Good conductivity and offers excellent elongation and flexibility. <u>SE1502 Data Sheet</u>	FHE Wearables			
SE3104	Stretchable Printed Insulator	ACI SE3104 is a screen printable, thermally cured ink that is stretchable when cured and compatible with ACI's stretchable inks. SE3104 can be used as an insulator and/or crossover dielectric.	FHE Wearables			
SE5025	Printed Fixed Resistance Heater Ink	ACI SE5025 is a stretchable resistive trace de- signed for heating applications integrated onto elastomeric substrates. When cured, the ink has a prescribed resistance value and offers excellent flexibility and stretchability.	FHE Wearables			



Thermal Management						
TM1077	Stretchable Die Attach Adhesive	Silver filled, solvent free, one component die attach adhesive that remains stretchable fol- lowing thermal cure. Designed for large dies and accommodates thermomechanical stress- es arising from differences in the thermal expansion coefficients between components. <u>TM1077 Data Sheet</u>	Thermal Mgmnt			
TM1079	Stretchable Die Attach Adhesive	Silver filled, solvent free, one component die attach adhesive that can undergo strains of up to 50% post cure. Designed for large dies and accommodates thermomechanical stresses arising from differences in the thermal expansion coefficients between components. <u>TM1079 Data Sheet</u>	Thermal Mgmnt			



Contact ACI Materials

805-845-3014 sales@acimaterials.com Visit our website: www.acimaterials.com